OSRAM GW QSLMS1.KM Datasheet

Published by ams-OSRAM AG Tobelbader Strasse 30, 8141 Premstaetten, Austria Phone +43 3136 500-0 ams-osram.com © All rights reserved





OSCONIQ[®] S 3030

GW QSLMS1.KM

The OSCONIQ[®] S 3030 is a high efficacy package for indoor professional applications. It uses sapphire flip chip technology and special phosphor technology to reach even higher performance than before. It offers excellent reliability and comes in a standard form factor to enable drop-in replacements.





Applications

- Indoor Lighting

Features

- Package: white SMT package
- Typ. Radiation: 120° (Lambertian emitter)
- Color temperature: 2700K 6500K
- CRI: 90 (min.), 92 (typ.), R9: 50 (min.)
- ESD: 8 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)
- Luminous Flux: typ. 39.8 lm @ 4000 K
- Luminous Efficacy: typ. 226 lm/W @ 4000 K
- Application: Suitable for General Lighting
- Stable deep dimming at low driving current from 1mA



Ordering Information

Туре	Color temperature	McAdams steps	Luminous Flux ¹⁾ I _F = 65 mA Φ_V	Ordering Code
GW QSLMS1.KM-H5H7-XX38-1	2700 K	SDCM 3	34.5 39.0 lm	Q65113A9601
GW QSLMS1.KM-H6H8-XX37-1	3000 K	SDCM 3	36.0 40.5 lm	Q65113A9600
GW QSLMS1.KM-H6H8-XX36-1	3500 K	SDCM 3	36.0 40.5 lm	Q65113A9599
GW QSLMS1.KM-H7H9-XX35-1	4000 K	SDCM 3	37.5 42.0 lm	Q65113A9598
GW QSLMS1.KM-H7H9-XX33-1	5000 K	SDCM 3	37.5 42.0 lm	Q65113A9597
GW QSLMS1.KM-H7H9-XX32-1	5700 K	SDCM 3	37.5 42.0 lm	Q65113A9596
GW QSLMS1.KM-H6H8-XX31-1	6500 K	SDCM 3	36.0 40.5 lm	Q65113A9595



Maximum Ratings

Parameter	Symbol		Values
Operating Temperature	T _{op}	min.	-40 °C
	θμ	max.	105 °C
Storage Temperature	T _{stg}	min.	-40 °C
	Sig	max.	120 °C
Junction Temperature	Tj	max.	110 °C
Forward Current	I _F	min.	1 mA
T _J = 25 °C	·	max.	200 mA
Reverse voltage 2)	V _R		Not designed for reverse operation
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)	V_{ESD}		8 kV

Note: Ensure the appropriate derating current is being used in order to maintain a junction temperature which is lower than the maximum allowable limit.



Characteristics

I_F = 65 mA; T_J = 25 °C

Parameter	Symbol		Values
Viewing angle at 50% I_v	2φ	typ.	120 °
Forward Voltage ³⁾	V _F	min. typ. max.	2.65 V 2.71 V 2.75 V
Reverse current ²⁾	Ι _R		Not designed for reverse operation
Color Rendering Index ⁴⁾	CRI	min. typ.	90 92
Color Rendering Index (R9) 4)	CRI (R9)	min.	50
Electrical thermal resistance junction/solderpoint with efficiency η_e = 67.8 %	$R_{thJSelec.}$	typ.	5.8 K / W



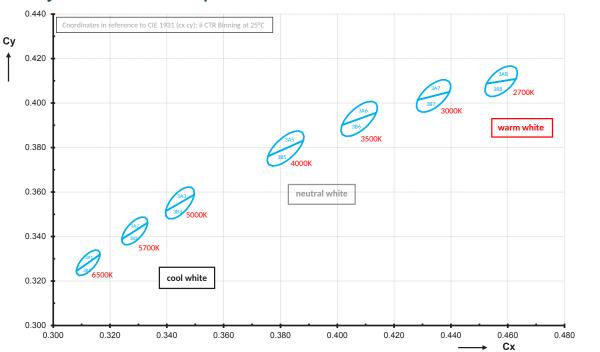
Brightness Groups

Group	Luminous Flux ¹⁾ I _F = 65 mA min. Φ _v	Luminous Flux ¹⁾ I _F = 65 mA max. Φ _v	
H5	34.5 lm	36.0 lm	
H6	36.0 lm	37.5 lm	
H7	37.5 lm	39.0 lm	
H8	39.0 lm	40.5 lm	
H9	40.5 lm	42.0 lm	

Forward Voltage Groups

Group	Forward Voltage ³⁾	Forward Voltage ³⁾	
	min.	max.	
	V _F	V _F	
1U	2.65 V	2.70 V	
1V	2.70 V	2.75 V	

1



OSRAM

Chromaticity Coordinate Groups ⁵⁾

Chromaticity Coordinate Groups

CCT	Center Cx	Center Cy	3step a	3step b	Ø
2700 K	0.4577	0.4098	0.008	0.0041	54.1
3000 K	0.4339	0.4032	0.0086	0.0042	53.7
3500 K	0.4077	0.3929	0.0093	0.0042	53.9
4000 K	0.3818	0.3796	0.0094	0.0041	53.4
5000 K	0.3446	0.3551	0.0081	0.0035	59.8
5700 K	0.3287	0.3425	0.0072	0.0032	58.8
6500 K	0.3123	0.3282	0.0066	0.0027	58.1



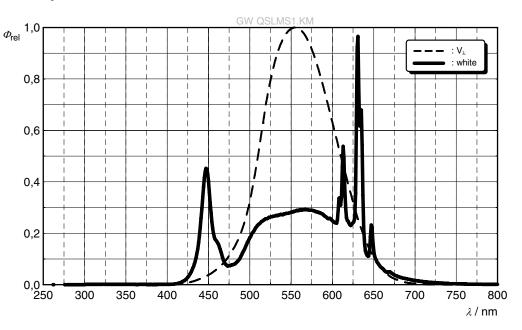
Group Name on Label

Example: H5-35-1U Brightness	Color Chromaticity	Forward Voltage	
H5	35	1U	



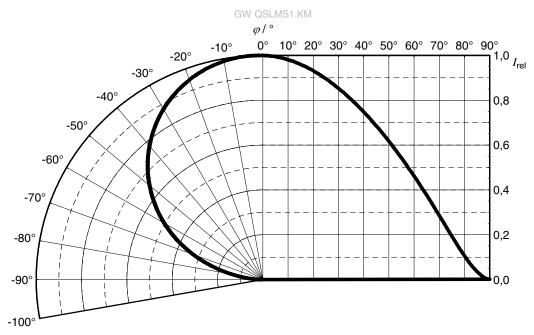
Relative Spectral Emission⁶⁾

 $\Phi_{_{rel}} = f(\lambda); I_{_F} = 65 \text{ mA}; T_{_J} = 25 \text{ }^{\circ}\text{C}$



Radiation Characteristics⁶⁾

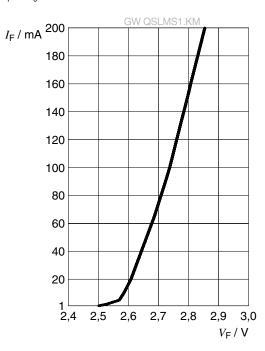
 $I_{rel} = f(\phi); T_J = 25 \ ^{\circ}C$





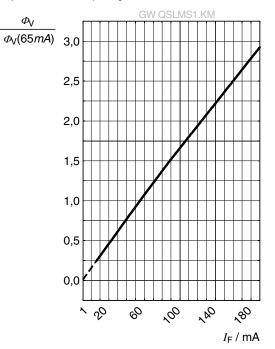
Forward current ⁶⁾

I_F = f(V_F); T_J = 25 °C



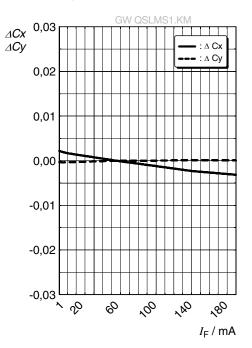
Relative Luminous Flux ^{6), 7)}

 $\Phi_{v}/\Phi_{v}(65 \text{ mA}) = f(I_{F}); T_{J} = 25 \text{ °C}$



Chromaticity Coordinate Shift ⁶⁾

 ΔCx , $\Delta Cy = f(I_F)$; $T_J = 25 \ ^{\circ}C$



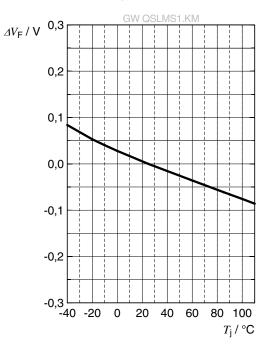
Note:

Luminous flux and color point for <10mA are for reference purpose and subject to measurement tolerance. They are excluded from standard tolerance window



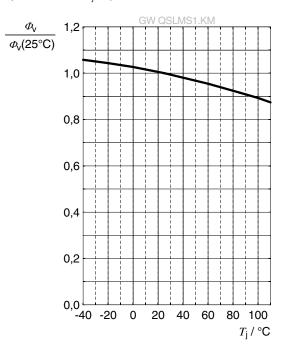
Forward Voltage ⁶⁾

 $\Delta V_{_{F}} = V_{_{F}} - V_{_{F}}(25 \text{ °C}) = f(T_{_{j}}); I_{_{F}} = 65 \text{ mA}$



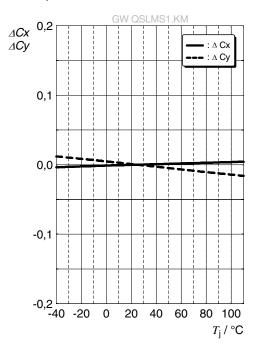
Relative Luminous Flux⁶⁾

 $\Phi_{v}/\Phi_{v}(25 \text{ °C}) = f(T_{i}); I_{F} = 65 \text{ mA}$



Chromaticity Coordinate Shift ⁶⁾

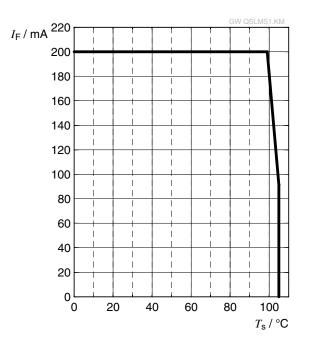
 ΔCx , $\Delta Cy = f(T_i)$; $I_F = 65 \text{ mA}$





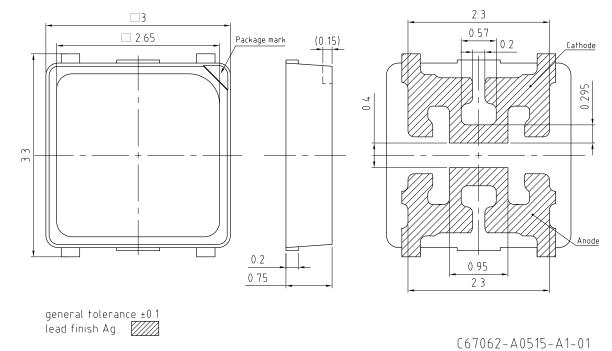
Max. Permissible Forward Current ⁸⁾

 $I_F = f(T)$





Dimensional Drawing⁹⁾



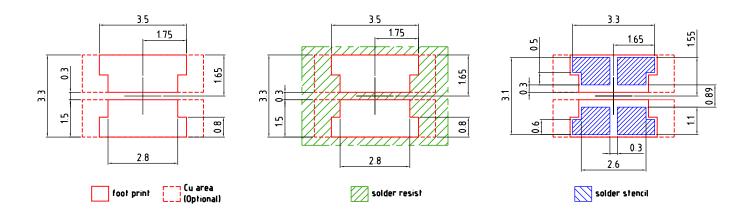
Further Information:

Approximate Weight: 17.8 mg

Package marking: Cathode



Recommended Solder Pad ⁹⁾

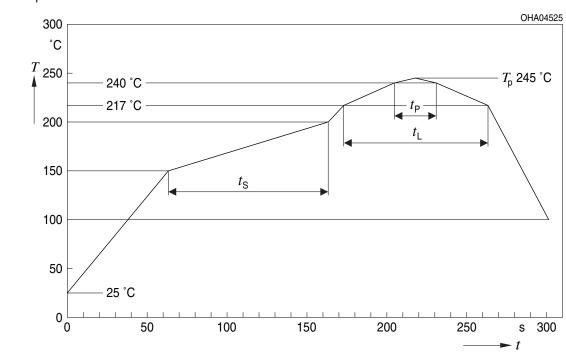


E067.0346.24-01

For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning.



Reflow Soldering Profile



Product complies to MSL Level 3 acc. to JEDEC J-STD-020E

Profile Feature	Symbol		-Free (SnAgCu) Ass	•	Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat ^{•)} 25 °C to 150 °C			2	3	K/s
Time t _s T _{smin} to T _{smax}	t _s	60	100	120	S
Ramp-up rate to peak ^{*)} $\rm T_{Smax}$ to $\rm T_{P}$			2	3	K/s
Liquidus temperature	TL		217		°C
Time above liquidus temperature	t		80	100	S
Peak temperature	Τ _Ρ		245	260	°C
Time within 5 °C of the specified peak temperature T_p - 5 K	t _P	10	20	30	S
Ramp-down rate* T _P to 100 °C			3	6	K/s
Time 25 °C to T _P				480	S

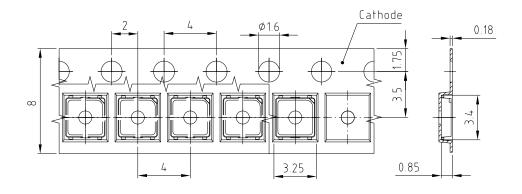
All temperatures refer to the center of the package, measured on the top of the component

* slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

GW QSLMS1.KM DATASHEET



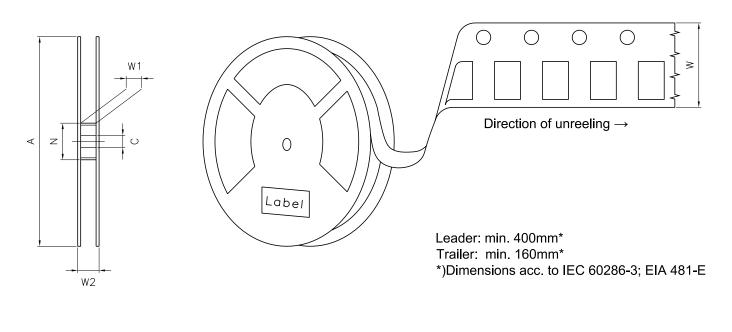
Taping 9)



C67062-A0515-B1-02



Tape and Reel ¹⁰⁾

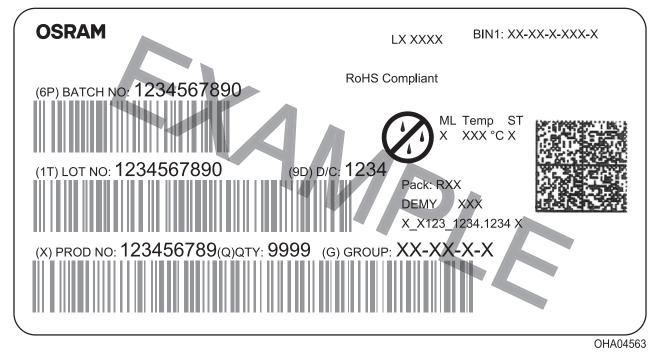


Reel Dimensions

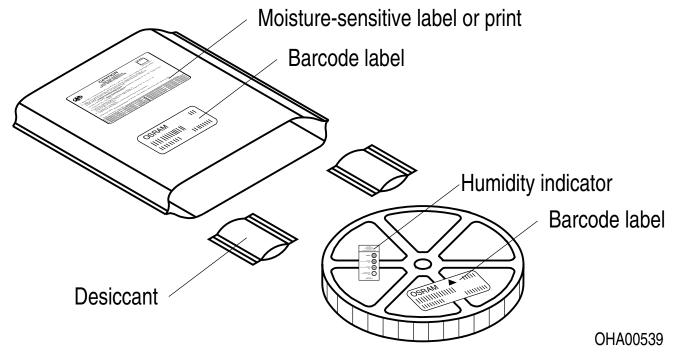
А	W	N _{min}	W ₁	$W_{2 \max}$	Pieces per PU
180 mm	8 + 0.3 / - 0.1 mm	53 mm	8.4 + 2 mm	14.4 mm	4000



Barcode-Product-Label (BPL)



Dry Packing Process and Materials





Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class **moderate risk (exposure time 0.25 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

This device is designed for specific/recommended applications only. Please consult OSRAM Opto Semiconductors Sales Staff in advance for detailed information on other non-recommended applications (e.g. automotive).

Change management for this component is aligned with the requirements of the lighting market.

For further application related information please visit https://ams-osram.com/support/application-notes



Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on our website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/ applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.



Glossary

- ¹⁾ **Brightness:** Brightness values are measured during a current pulse of typically 45 ms (measurement starts with a delay of 25 ms), with a tolerance of +/- 5%.
- ²⁾ **Reverse Operation:** Not designed for reverse operation. Continuous reverse operation can cause migration and damage of the device.
- ³⁾ **Forward Voltage:** The Forward voltage is measured during a current pulse duration of typically 45 ms (measurement starts with a delay of 25 ms) with a tolerance of \pm 0.05V.
- ⁴⁾ Color reproduction index: Color reproduction index values (CRI-RA) are measured during a current pulse of typically 45 ms (measurement starts with a delay of 25 ms) and with a tolerance of ±2. CRI-R9 are measured during a current pulse of typically 45 ms (measurement starts with a delay of 25 ms) and the 4000K with a tolerance of ±6.
- ⁵⁾ **Chromaticity coordinate groups:** Chromaticity coordinate groups are measured during a current pulse duration of typically 10ms with a tolerance of ±0.005.
- ⁶⁾ Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- ⁷⁾ **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- ⁸⁾ Thermal Resistance: Rth max is based on statistic values (6σ) used for Derating.
- ⁹⁾ **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- ¹⁰⁾ **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.



Revision History

Version	Date	Change
1.0	2025-01-24	Initial Version



EU RoHS and China RoHS compliant product 此产品符合欧盟 RoHS 指令的要求; 按照中国的相关法规和标准, 不含有毒有害物质或元素。

Published by ams-OSRAM AG Tobelbader Strasse 30, 8141 Premstaetten, Austria Phone +43 3136 500-0 ams-osram.com © All rights reserved

